



Product Change Notification

112457 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 112457 - 00
Change Title: Intel® Spare Power Distribution Board
 FXXLHPPDB
 PCN 112457-00, Product Design
 BOM Change
Date of Publication: August 1, 2013

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

* Date Customer Must be Ready to Receive Post-Conversion Material:	Aug 16, 2013
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel will implement the following changes on Intel® Spare Power Distribution Board FXXLHPPDB:

1. Update the Power Distribution Board from TA# revision G48543-001 to G48543-002. Intel has made a continuous improvement BOM change to the Over Current Protection (OCP) trip reporting when using a PSU with a slow stand-by power ramp rate.

Customer Impact of Change and Recommended Action:

Intel recommends that the customer perform a standard level of evaluation as updated product become available.

Customers need to place future orders using the new Order Code (MM#) as noted in below table.

Products Affected / Intel Ordering Codes:

Product Code	Pre Change MM#	Pre Change TA	Pre Change PBA	Post Change MM#	Post Change TA	Post Change PBA
FXXLHPPDB	921254	G48543-001	G38282-302	931958	G48543-002	G38282-303

PCN Revision History:

Date of Revision: August 1, 2013	Revision Number: 00	Reason: Originally Published PCN
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